imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Transistors with Built-in Resistor DRA9144E0L

DRA9144E0L Silicon PNP epitaxial planar type

For digital circuits Complementary to DRC9144E DRA5144E in SSMini3 type package

Features

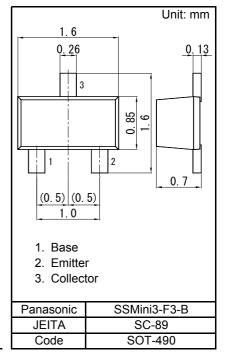
- · Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Absolute Maximum Ratings Ta = 25 °C

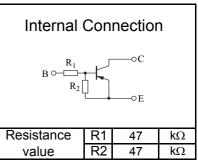
Marking Symbol: LL

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



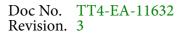
Parameter	Symbol	Rating	Unit	-
Collector-base voltage (Emitter open)	VCBO	-50	V	
Collector-emitter voltage (Base open)	VCEO	-50	V	
Collector current	IC	-100	mA	
Total power dissipation	PT	125	mW	
Junction temperature	Tj	150	°C	
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	°C	



Electrical Characteristics Ta = $25 \circ C \pm 3 \circ C$

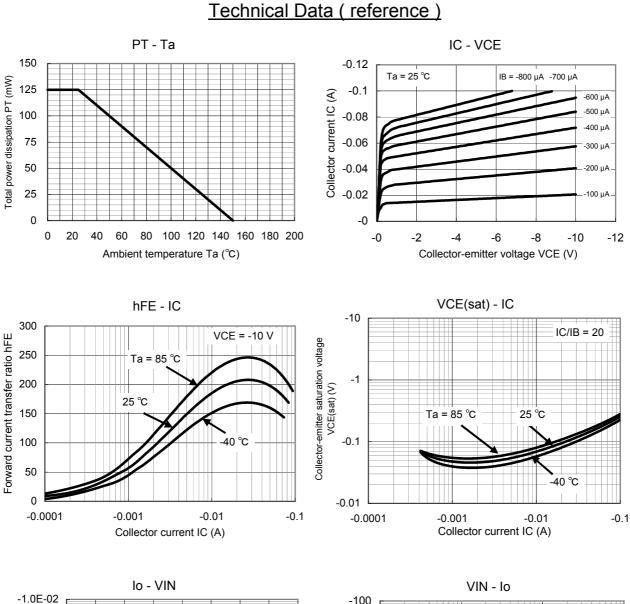
Electrical characteristics Ta = 25 C		Conditions	Min	T. m	Max	1.1
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	VCBO	IC = -10 μA, IE = 0	-50			V
Collector-emitter voltage (Base open)	VCEO	IC = -2 mA, IB = 0	-50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = -50 V, IE = 0			-0.1	μA
Collector-emitter cutoff current (Base open)	ICEO	VCE = -50 V, IB = 0			-0.5	μA
Emitter-base cutoff current (Collector open)	IEBO	VEB = -6 V, IC = 0			-0.1	mA
Forward current transfer ratio	hFE	VCE = -10 V, IC = -5 mA	80			-
Collector-emitter saturation voltage	VCE(sat)	IC = -10 mA, IB = -0.5 mA			-0.25	V
Input voltage	Vi(on)	VCE = -0.2 V, IC = -5 mA	-3.6			V
	Vi(off)	VCE = -5 V, IC = -100 µA			-0.8	V
Input resistance	R1		-30%	47	+30%	kΩ
Resistance ratio	R1/R2		0.8	1.0	1.2	-

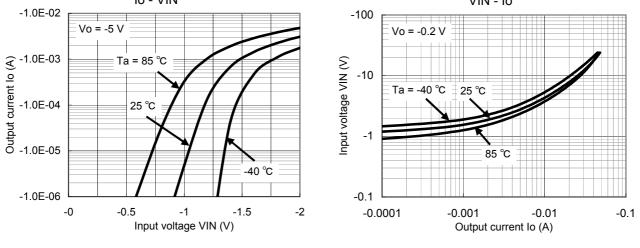
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.



Panasonic

Transistors with Built-in Resistor DRA9144E0L





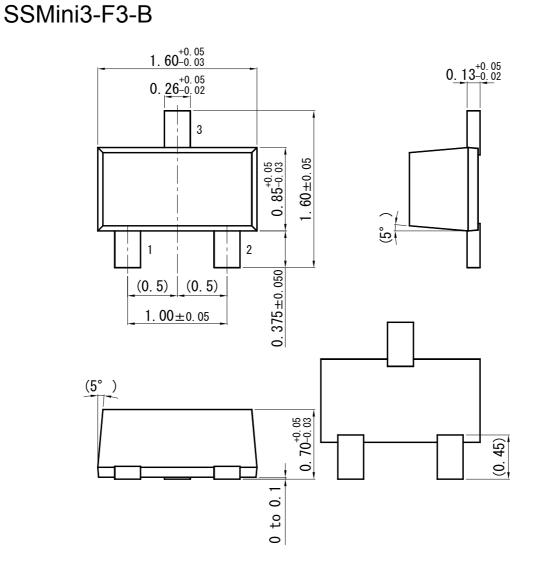
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Established : 2009-10-16 Revised : 2014-02-24

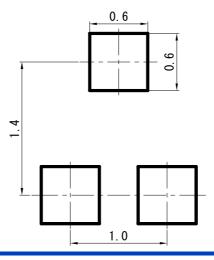


Transistors with Built-in Resistor DRA9144E0L

Unit: mm



Land Pattern (Reference) (Unit: mm)



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